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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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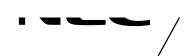
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MOS FIELD EFFECT TRANSISTOR NP161N04TUG

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The NP161N04TUG is N-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
NP161N04TUG-E1-AY Note			
NP161N04TUG-E2-AY Note	Pure Sn (Tin)	Tape 800 p/reel	TO-263-7pin (MP-25ZT) typ. 1.5 g

Note Pb-free (This product does not contain Pb in the external electrode).

FEATURES

• Super low on-state resistance

 $R_{DS(on)} = 1.35 \text{ m}\Omega \text{ TYP.} / 1.8 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, I_{D} = 80 \text{ A})$

• High Current Rating

 $I_{D(DC)} = \pm 160 \text{ A}$

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	40	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±160	Α
Drain Current (pulse) Note1	ID(pulse)	±640	Α
Total Power Dissipation (Tc = 25°C)	P _{T1}	250	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	1.8	W
Channel Temperature	Tch	175	°C
Storage Temperature	T _{stg}	-55 to +175	°C
Repetitive Avalanche Current Note2	Iar	70	Α
Repetitive Avalanche Energy Note2	Ear	650	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Tch = 150°C, VDD = 25 V, Rg = 25 Ω , Vgs = 20 \rightarrow 0 V, L = 100 μ H

THERMAL RESISTANCE

Channel to Case Thermal Resistance °C/W $R_{th(ch-C)}$ 0.6 Channel to Ambient Thermal Resistance °C/W Rth(ch-A)

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Vgs

90%



ELECTRICAL CHARACTERISTICS (TA = 25°C)

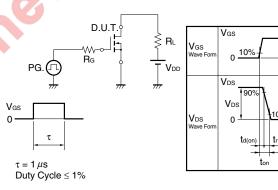
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 40 V, V _{GS} = 0 V			1	μΑ
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
Gate to Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2.0	3.0	4.0	V
Forward Transfer Admittance Note	yfs	V _{DS} = 5 V, I _D = 40 A	35	88		S
Drain to Source On-state Resistance Note	R _{DS(on)}	V _{GS} = 10 V, I _D = 80 A		1.35	1.8	mΩ
Input Capacitance	Ciss	V _{DS} = 25 V,		13500	20250	pF
Output Capacitance	Coss	V _{GS} = 0 V,		1200	1800	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		750	1350	pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 20 V, I _D = 80 A,		50	110	ns
Rise Time	tr	V _{GS} = 10 V,		40	100	ns
Turn-off Delay Time	t _{d(off)}	R _G = 0 Ω		110	220	ns
Fall Time	tf			20	40	ns
Total Gate Charge	Q _G	V _{DD} = 32 V,		230	345	nC
Gate to Source Charge	QGS	V _{GS} = 10 V,		50		nC
Gate to Drain Charge	Q _{GD}	lo = 160 A		75		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 160 A, V _{GS} = 0 V		0.9	1.5	V
Reverse Recovery Time	trr	IF = 160 A, VGS = 0 V,		60		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		100		nC

Note Pulsed test

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V}$ V_{DD} V_{DD} D.U.T. V_{DD} V_{DD} V_{DD} V_{DD} V_{DD} V_{DD} V_{DD}

TEST CIRCUIT 2 SWITCHING TIME



TEST CIRCUIT 3 GATE CHARGE

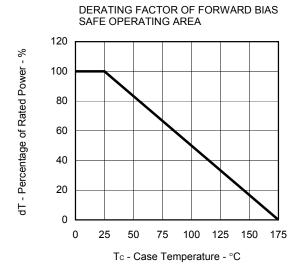
$$\begin{array}{c|c}
D.U.T. & \\
I_G = 2 \text{ mA} & \\
\hline
PG. & \\
\end{array}$$

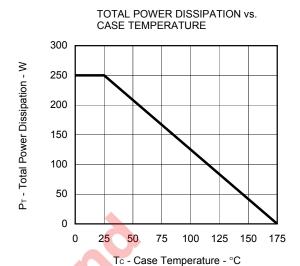
$$\begin{array}{c|c}
PG. & \\
\end{array}$$

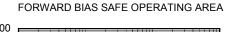
$$\begin{array}{c|c}
\end{array}$$

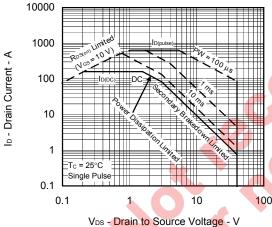
Starting Tch

TYPICAL CHARACTERISTICS (TA = 25°C)

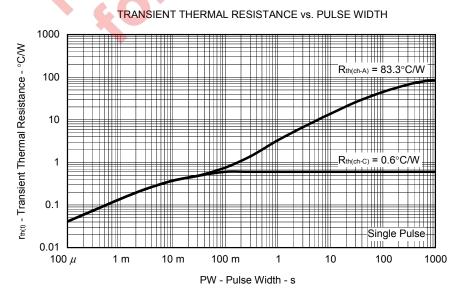




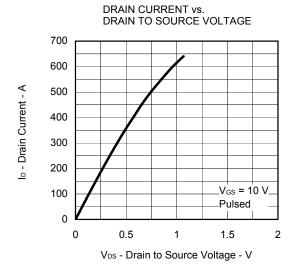




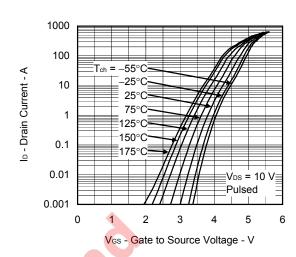




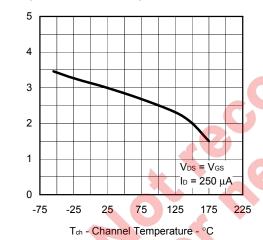
3



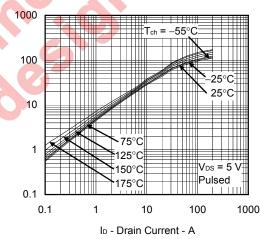
FORWARD TRANSFER CHARACTERISTICS



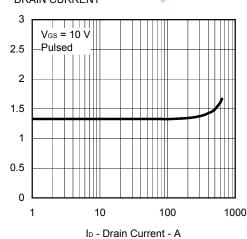
GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



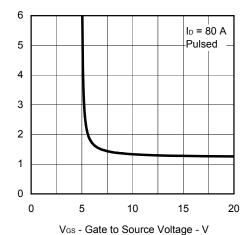
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

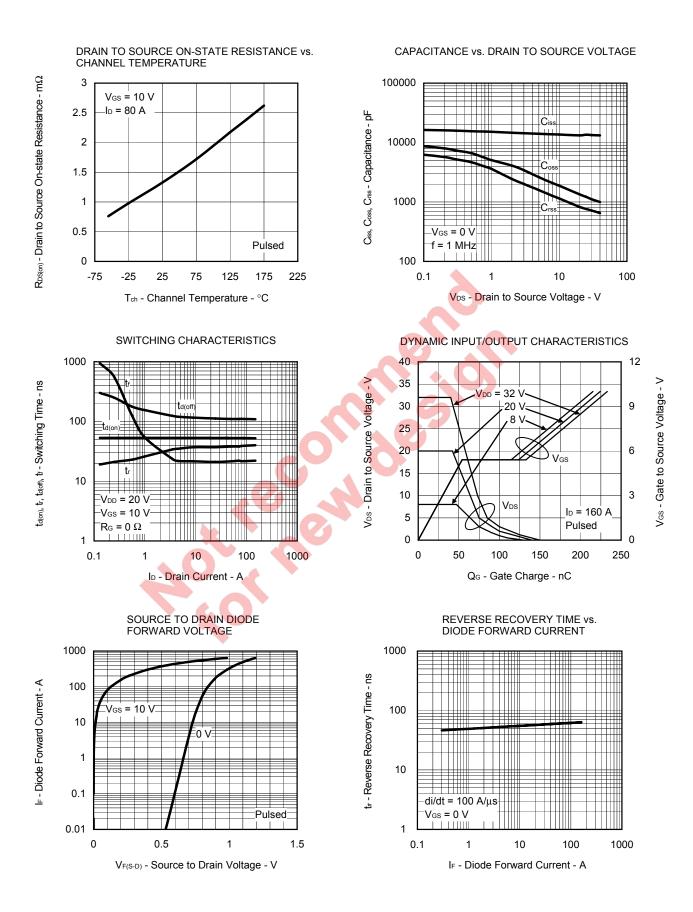


 $\mathsf{Res}_{(\mathsf{on})}$ - Drain to Source On-state Resistance - $m\Omega$

Vcs(th) - Gate to Source Threshold Voltage - V

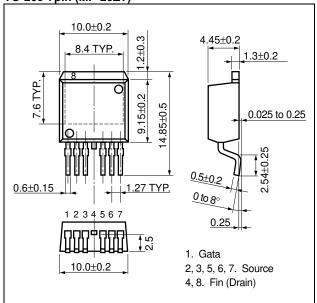
| yfs | - Forward Transfer Admittance -

R_{DS(∞)} - Drain to Source On-state Resistance - mΩ

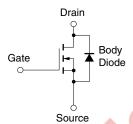


PACKAGE DRAWING (Unit: mm)

TO-263-7pin (MP-25ZT)



EQUIVALENT CIRCUIT

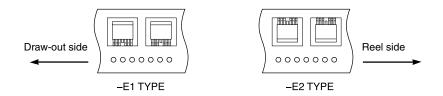


Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

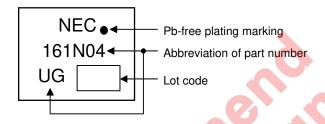
6

TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



MARKING INFORMATION



RECOMMENDED SOLDERING CONDITIONS

The NP161N04TUG should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below Time at maximum temperature: 10 seconds or less Time of temperature higher than 220°C: 60 seconds or less Preheating time at 160 to 180°C: 60 to 120 seconds	IR60-00-3
	Maximum number of reflow processes: 3 times Maximum chlorine content of rosin flux (percentage mass): 0.2% or less	
Partial heating	Maximum temperature (Pin temperature): 350°C or below Time (per side of the device): 3 seconds or less Maximum chlorine content of rosin flux: 0.2% (wt.) or less	P350

Caution Do not use different soldering methods together (except for partial heating).

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